

Upcoming: March 31–April 4, MRS Spring Meeting.

To list an event in the Calendar, contact **J. Meiksin, Materials Research Society, 9800 McKnight Road, Pittsburgh, PA 15237-6006; (412) 367-3004 ext. 522; fax (412) 367-4373.**

MRS, A-MRS, C-MRS, E-MRS, MRS-I, MRS-J, MRS-K, MRS-R, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the January 1997 MRS BULLETIN for February 1997 Calendar entries.

APRIL 1997

2-4 ▼ 6th Intl. Conf. on Multichip Modules, *Denver, CO*. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; (703) 758-1060; fax (703) 758-1066; e-mail imaps@aol.com.

7-8 Northeast Univ. Industry Technology Transfer Conf., *Philadelphia, PA*. L.W. Sircy, Technology Transfer Conferences, Inc., 325 Plus Park Blvd., #108, Nashville, TN 37217; (615) 366-0679; fax (615) 366-0695.

7-9 ▼ 4th HTS Workshop on High-Frequency Applications of Thin Films, Fabrication, Passive and Active Devices, *Oxford, UK*. C.R.M. Grovenor, Dept. of Engineering Science, fax 44-1865-273010; e-mail grovenor@materials.oxford.ac.uk; World Wide Web <http://www.materials.ox.ac.uk/Materials/Conferences/hts4thinfilms.html>.

7-9 4th Nürnberg Congress: Creative Advances in Coatings Technology, *Nürnberg, Germany*. Conf. Secretariat, Paint Research Association, 8 Waldegrave Rd., Teddington, Middlesex TW11 8LD, UK; 44-181-9774427; fax 44-181-9434075.

7-9 ▼ 5th Intl. Conf. on Advanced Particulate Materials and Processes, *West Palm Beach, FL*. B. Sun, Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; (609) 452-7700; fax (609) 987-8523; e-mail info@mpif.org; World Wide Web <http://www.mpi.org/mpif>.

7-10 Microscopy of Semi-conducting Materials, *Oxford, UK*. The Administrator, Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-18-65-248768; fax 44-18-65-791237.

8-10 ▼ Thermal Spray Coatings '97, *Atlanta, GA*. A.P. Molloy, Gorham Advanced Materials, P.O. Box 250, Gorham, ME 04038; (207) 892-5445; (207) 892-2210; e-mail gorham@goradv.com.

8-11 4th Intl. Multidisciplinary Conf.: Fractals in the Natural and Applied Sciences, *Denver, CO*. M.M. Novak, 44-181-547-2000; fax 44-181-547-7562; e-mail novak@kingston.ac.uk; World Wide Web http://www.kingston.ac.uk/~ap_s412.

9-11 12th Intl. Conf. on Boundary Element Technology, *Knoxville, TN*. L. Kerr, BETECH 97 Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-1703-293223; fax 44-1703-292853; e-mail wit@wessex.witcni.ac.uk; World Wide Web <http://www.witcni.ac.uk>.

12-17 Society of Vacuum Coaters 40th Anniversary Technical Conf., *New Orleans, LA*. Society of Vacuum Coaters, 440 Live Oak Loop N.E., Albuquerque, NM 87122-1407; (505) 856-7188; fax (505) 856-6176; e-mail svcinfo@svc.org.

13-17 8th Biennial Workshop on Organometallic Vapor Phase Epitaxy, *Dana Point, CA*. TMS Customer Service, 420 Commonwealth Dr., Warrendale, PA 15086; (412) 776-9000; fax (412) 776-3770; e-mail csc@tms.org.

14-15 ▼ Intl. Symposium on Valvetrain System Design and Materials, *Dearborn, MI*. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; (216) 338-5151; fax (216) 338-4634; e-mail memserv@po.asm-intl.org.

14-17 40th Technical Conf. of the Society of Vacuum Coaters, *New Orleans, LA*. Society of Vacuum Coaters, 440 Live Oak Loop, Albuquerque, NM 87122-1407; (505) 856-7188; fax (505) 856-6716; e-mail svcinfo@svc.org; World Wide Web <http://www.svc.org>.

15-17 ▼ 8th Users Meeting for the Advanced Photon Source, *Argonne, IL*. L. Carlson, Advanced Photon Source, Argonne Natl. Lab., Bldg. 401, Rm. B1168, 9700 S. Cass Ave., Argonne, IL 60439-4800; World Wide Web <http://www.aps.anl.gov>.

15-18 Ceramics and Marble '97, *Shanghai, P.R. China*. Worldwide Exhibitions Service Co., Ltd., Rm. 628, Bldg. 3, 1486 Nanjing Rd., Shanghai 200040, P.R. China; 86-21-62470160; fax 86-21-62474030; e-mail wes-expo@stn.sh.cn.

16 Microscopy of Biomaterials, *Bath, England*. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-18-65-248768; fax 44-18-65-791237.

18-21 ▼ 1997 Joint APS/AAPT Meeting with the Div. of Atomic, Molecular, and Optical Physics Annual Meeting, *Washington, DC*. The American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; (301) 209-3286; fax (301) 209-0866; World Wide Web <http://www.aps.org>.

19-22 ▼ Scanning 97—9th Annual Intl. Scientific Meeting sponsored by the Foundation for Advances in Medicine and Science, *Monterey, CA*. Scanning 97, P.O. Box 832, Mahwah, NJ 07430-0832; (201) 818-1010; fax (201) 818-0086; e-mail fams@holonet.net.

20-25 Intl. Symposium on Aerospace Defense Sensing and Control and Dual-Use Photonics, *Orlando, FL*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; (360) 676-3290; fax (360) 647-1445; e-mail spie@spie.org; World Wide Web <http://www.spie.org>.

21-23 Euromat 97: Materials, Functionality and Design, *Maastricht, The Netherlands*. EUROMAT 97, P.O. Box 390, NL 3330 AJ Awjindericht; 31-78-619-2655; fax 31-78-619-5735; e-mail bvm@metropolis.nl.

21-25 American Vacuum Society Intl. Conf. on Metallurgical Coatings and Thin Films, *San Diego, CA*. M.S. Gray, ICMCTF 97, Ste. 502, 1090G Smallwood Dr., Waldorf, MD 20603; (301) 870-8756; fax (301) 645-1426.

21-25 ▼ Intl. Conf. on Metallurgical Coatings and Thin Films, *San Diego, CA*. M.S. Gray, ICMCTF 97, Conf. Secretary, Ste. 502, 1090 G Smallwood Dr., Waldorf, MD 20603; fax (301) 645-1426.

22-25 12th Intl. Conf. on Solid Compounds of Transition Elements, *Saint-Malo, Brittany, France*. H. Noël, 33-99-28-62-55; fax 33-99-63-57-04; e-mail scte97@univ-rennes1.fr; World Wide Web <http://www.univ-rennes1.fr/scte97>.

25-30 SOLAR 97 Conf. in conjunction with Soltech 97, *Washington, DC*. American Solar Energy Society®, 2400 Central Ave., G-1, Boulder, CO 80301; (303) 443-3130; fax (303) 443-3212.

27-29 ▼ Free Boundary Problems in Superconductivity Device and Process Modeling, *SPA, Belgium*. R. Cloots, SUPRAS, B6, Univ. de Liège, B-4000 Liège, Belgium; 32-4-366-3436; fax 32-4-366-2990; e-mail cloots@gw.unipcl.ac.be; World Wide Web <http://www.phe.ulg.ac.be/fbp.html>.

27-1 4th Intl. Conf. on High-Temperature Intermetallics, *San Diego, CA*. Sharon Knee, (423) 574-4343 or Connie Dowker, (423) 574-5120; fax (423) 574-7659.

27-1 Intl. Mining Trade Show and 99th Annual Meeting of the Canadian Inst. of Mining, Metallurgy and Petroleum, *Vancouver, British Columbia, C.* Murphy, CIM Secretariat, Canadian Inst. of Mining, Metallurgy and Petroleum, Xerox Tower, 1210-3400 de Maisonneuve Blvd. W., Montreal, Quebec, H3Z 3B8, Canada; (514) 939-2710; fax (514) 939-2714; e-mail cmcim@login.net.

MAY 1997

4-7 American Ceramic Society 99th Annual Meeting, *Cincinnati, OH*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; (614) 794-5890; fax (614) 899-6109; e-mail customersvc@acers.org.

4-8 Inst. of Environmental Sciences 43rd Annual Technical Meeting, *Los Angeles, CA*. Inst. of Environmental Sciences, 940 E. Northwest Hwy., Mt. Prospect, IL 60056; (847) 255-1561; fax (847) 255-1699.

4-9 26th State-of-the-Art Program on Compound Semiconductors, *Montreal, Canada*. D.N. Buckley, Dept. of Physics, Univ. of Limerick, Limerick, Ireland; 353-61-202902; fax 353-61-202423; e-mail noel.buckley@ul.ie; World Wide Web <http://www.electrochem.org>.

4-9 43rd Annual Meeting of the Inst. of Environmental Sciences, *Los Angeles, CA*. Inst. of Environmental Sciences, 940 E. Northwest Hwy., Mt. Prospect, IL 60056; (708) 255-1561; fax (708) 255-1699.

4-9 ▼ 191st Meeting of the Electrochemical Society, *Montreal, Quebec, Canada*. The Electrochemical Society, Inc., 10 S. Main St., Pennington, NJ 08534-2896; (609) 737-1902; fax (609) 737-2743; e-mail ecs@electrochem.org; World Wide Web <http://www.electrochem.org>.

4-9 Fullerenes: Chemistry, Physics, and New Directions IX, *Montreal, Canada*. K.M. Kadish, Dept. of Chemistry, Univ. of Houston, Houston, TX 77204-5641; (713) 743-2740; fax (713) 743-2745; e-mail kkadish@uh.edu.

5-8 ▼ 42nd Intl. SAMPE Symposium and Exhibition, *Anaheim, CA*. SAMPE Intl. Business Office, P.O. Box 2459, Covina, CA 91722; (818) 331-0616; fax (818) 332-8929; e-mail sampeibo@aol.com; World Wide Web <http://www.et.byu.edu/~sampe>.

6-8 Electronics Industries Forum of New England, *Boston, MA*. Summit Exhibition Mgmt., 40 Richards Ave., Norwalk, CT 06854; (800) 322-9332; fax (203) 855-3003.

8 ▼ Massachusetts Biotechnology Council 1997 Biotechnology Symposium and Exposition, *Cambridge, MA*. Massachusetts Biotechnology Council, 245 First St., 14th Floor, Cambridge, MA 02142; (617) 577-8198; fax (617) 577-7860; World Wide Web <http://www.massbio.org>.

11-14 8th Intl. Conf. on the Joining of Materials, *Helsingør, Denmark*. Secretariat, JOM-Inst., DTU - Helsingør, Rasmus Knudsens Vej 50, DK-3000 Helsingør, Denmark; 45-49-216622; fax 45-79-707036; e-mail al@ism.dtu.dk.

11-15 ▼ 9th Intl. Conf. on Indium Phosphide and Related Materials, *Hyannis, MA*. IPRM'97, IEEE Lasers and Electro-Optics Society, 445 Hoes Lane, P.O. Box 1331, Piscataway, NJ 08855-1331; (908) 562-3898.

11-15 European Microbeam Analysis Society Workshop, *Torquay, England*. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-18-65-248768; fax 44-18-65-791237.

12-14 2nd Intl. Symposium on Plasma Process-Induced Damage, *Monterey, CA*. D. Miller, Northern California Chapter, American Vacuum Society, 150 W. Iowa Ave., Ste. 104, Sunnyvale, CA 94086; (408) 737-0767; fax (408) 737-2403; e-mail nccavs@technicalmarketing.com.

12-14 2nd SIAM Conf. on Mathematical Aspects of Materials Science, *Philadelphia, PA*. SIAM, 3600 University City Science Center, Philadelphia, PA 19103-2688; (215) 382-9800; fax (215) 386-7999; e-mail meetings@siam.org; World Wide Web <http://www.siam.org/conf.htm>.

12-15 ▼ 8th Advanced Aerospace Materials and Processes Conf., *Williamsburg, VA*. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; (216) 338-5151; fax (216) 338-4634; e-mail memserv@po.asm-intl.org.

12-16 ▼ 1997 Particle Accelerator Conf. and Annual Meeting of the Div. of Physics of Beams, *Vancouver, BC, Canada*. L. Stanford, M.S. H850, LANL, P.O. Box 1663, Los Alamos, NM 87545; (505) 667-5634; fax (505) 665-8604; e-mail stanford_l@lanl.gov; World Wide Web <http://www.triumf.ca/pac97.html>.

15-17 DIMACS Workshop on Combinatorial Optimization and Disordered Materials: Recent Progress and Algorithmic Challenges, *Piscataway, NJ*. P.M. Duxbury, (517) 353-9179; fax (517) 353-0690; e-mail duxbury@pa.msu.edu; World Wide Web <http://dimacs.rutgers.edu/workshops/index.html>.

18-23 Conf. on Lasers and Electro-Optics/Quantum Electronics and Laser Science Conf., *Baltimore, MD*. CLEO/QELS '97, Optical Society of America, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; (202) 223-0920; fax (202) 416-6100.

19-20 Western Univ. Industry Technology Transfer Conf., *San Francisco, CA*. L.W. Sircy, Technology Transfer Conferences, Inc., 325 Plus Park Blvd., #108, Nashville, TN 37217; (615) 366-0679; fax (615) 366-0695.

19-21 2nd Intl. Conf. on Low Dimensional Structures and Devices, *Lisbon, Portugal*. R. Sheppard, LIDS '97, Elsevier Advanced Technology, P.O. Box 150, Kidlington, Oxford OX5 1AS, UK; 44-18-65-843848; e-mail r.sheppard@elsevier.co.uk.

19-22 ▼ 2nd Joint China/USA Chemical Engineering Conf., *Beijing, China*. T. Guttilla; (212) 705-7373; e-mail terrg@aiche.org.

19-23 9th Intl. Conf. on High-Temperature Materials Chemistry, *State College, PA*. K.E. Spear, Materials Science and Engineering Dept., The Pennsylvania State Univ., 118 Steidle Bldg., University Park, PA 16802-5005; (814) 863-0990; fax (814) 865-2917; e-mail kes@psu.edu; World Wide Web <http://www.cde.psu.edu/c&i/htrmc-ix/>.

19-23 Modification of Ceramics and Semiconductors by Ion Bombardment, *Il Ciocco, Italy*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; (212) 705-7836; fax (212) 705-7441; e-mail engfnd@aol.com; World Wide Web <http://engfnd.org/engfnd>.

25-28 5th European Powder Diffraction Conf., *Parma, Italy*. G. Artioli, Univ. degli Studi di Milano, Dipartimento di Scienze della Terra, Via Botticelli 23, I-20133 Milano, Italy; 39-2-23698320; fax 39-2-70638681; e-mail epdic@iunmix.terra.unimi.it; World Wide Web <http://iunmix.terra.unimi.it/~epdic/epdic-5.html>.

25-29 9th Intl. Symposium on Intercalation Compounds, *Bordeaux-Arcachon, France*. ISIC 9, Centre de Recherché Paul Pascal, Ave. Albert Schweitzer, F-33600 Pessac, France; 33-56-845632; fax 33-56-845600; e-mail mondolfi@crpp.u-bordeaux.fr.

25-29 11th Intl. Colloquium on Plasma Processes, *Le Mans, France*. CIP'97, Societe Francaise du Vide, 19, rue du Renard, 75004 Paris, France; 33-1-53-019030; fax 33-1-42-786320.

25-30 7th Intl. Offshore and Polar Engineering Conf., *Honolulu, HI*. J.S. Chung, c/o Dept. of Engineering, Colorado School of Mines, 1500 Illinois St., Golden, CO 80401; (303) 273-3673; fax (303) 420-3760.

26-28 ▼ Intl. Workshop on Ti- and Hg-Based Superconducting Materials, *Cambridge, UK*. S. Wu, IRC in Superconductivity, Univ. of Cambridge, Cambridge CB3 0HE, UK; fax 44-1223-33-7074; e-mail sw204@cus.cam.ac.uk.

JUNE 1997

1-4 2nd Greek-Italian Intl. Conf. on New Laser Technologies and Applications, *Ancient Olympia, Greece*. A. Carabelas, Solonos 12, Kastellokambos, 26442 Patra, Greece; fax 0030-61-991626.

1-4 15th Conf. on Crystal Growth and Epitaxy, *Fallen Leaf Lake, CA*. J.E. Huffman, Rockwell Science Ctr., 3370 Miraloma Ave., HA 17, Anaheim, CA 92803; (714) 762-4011; e-mail jehuffman@anet.rockwell.com.

2-5 1997 Intl. Conf. on GaAs Manufacturing Technology, *San Francisco, CA*. B. Hewitt, Northrop Grumman Corp., P.O. Box 1521, MS 3K13, Baltimore, MD 21203; (410) 765-1964, fax (410) 765-7370; e-mail hewitt.b@postal.essd.northgrum.com.

2-7 ▼ Microspheres—Microcapsules Technology Workshop, *Moscow, Russia*. N. Borisenko; fax 007-095-938-2251; e-mail ngbor@sci.lpi.msk.su.

4-6 ▼ 4th Intl. Symposium on Sputtering and Plasma Processes, *Kanazawa, Japan*. Y. Chijimatsu, ISSP'97 Secretariat, Japan Technology Transfer Assoc., Dai-ni Koujimachi 4-2, Chiyoda-ku, Tokyo 102, Japan; 81-3-3238-5300; fax 81-3-3238-5388; e-mail XLD04163@niftyserve.or.jp.

4-6 4th Intl. Workshop on Stress-Induced Phenomena in Metallizations, *Tokyo, Japan*. Hidekazu Okabayashi, NEC Corporation, Research and Development Group, Miyukigaoka 34, Tsukuba 305, Japan; 81-298-50-1105; e-mail okabayas@lbr.cl.nec.co.jp.

8-11 7th European Workshop on Metal-Organic Vapor Phase Epitaxy and Related Growth Techniques, *Berlin, Germany*. U. Knospe, Secretary, Heinrich-Hertz-Inst. für Nachrichtentechnik Berlin GmbH, Einsteinufer 37, D-10587 Berlin, Germany; 49-30-31002-557; fax 49-30-31002-558; e-mail knospe@mails.hhi.de.

8-12 ▼ Intl. Biotechnology Meeting, *Houston, TX*. Massachusetts Biotechnology Council, 245 First St., 14th Floor, Cambridge, MA 02142; (617) 577-8198; fax (617) 577-7860; World Wide Web <http://www.massbio.org>.

8-13 ▼ 1997 IEEE MTT-S Intl. Microwave Symposium, *Denver, CO*. V. Nair, Technical Program Chair, (602) 413-5922; fax (602) 413-5934; e-mail v.nair@ieee.org; World Wide Web <http://www.ieee.org/mtt/mtt.html>.

8-13 ▼ 3rd Mediterranean Workshop and Meeting on Novel Optical Materials and Applications, *Cetraro, Italy*. C. Umerton, Dipartimento di Fisica, Univ. della Calabria, 87036 Rende (CS), Italy; fax 39-984-839389; e-mail umerton@fis.unical.it.

8-20 ▼ NATO Advanced Study Inst. on Applications of Superconductivity, *Loen, Norway*. H. Weinstock, AFOSR/NE, Bolling AFB, DC 20332-8080; fax (202) 767-4986; e-mail harold.weinstock@afosr.af.mil.

9-11 3rd Intl. Conf. on Computers in Biomedicine, *Terni (Umbria), Italy*. P. Dougherty-Young, BIOMED 97 Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-1703-293223; fax 44-1703-292853; e-mail paula@wessex.witcmi.ac.uk; World Wide Web <http://www.witcmi.ac.uk>.

9-14 25th Intl. Meeting on Chemical Engineering, Environmental Protection, and Biotechnology, *Frankfurt am Main, Germany*. DECHEMA e.V., Ausstellungsstagen, Postfach 15 01 04, D-60061 Frankfurt am Main, Germany; 49-69-7564-0; fax 49-69-7564-201.

10-12 ▼ Fundamental Research Needs in Ceramics, *Washington, DC*. L.J. Schioler, Ceramics Program Director, e-mail Ischirole@nsf.gov; (703) 306-1836; fax (703) 306-0515.

11-13 3rd Recycling of Metals Conf., *Barcelona, Spain*. B. Roudebush, ASM Intl. European Office, Blvd. St. Michel 15, B-1040 Brussels, Belgium; 32-2-7431546; fax 32-2-7431550; e-mail 100332.670@compuserve.com.

11-13 4th Intl. Colloquium on Process Simulation, *Espoo, Finland*. P. Attila, Helsinki Univ. of Technology, TKK-V, FIN-02150 Espoo, Finland; 358-0-451-2768; fax 358-0-451-2799; e-mail ari.jokilaako@hut.fi; World Wide Web <http://www.hut.fi/tkk/jauhe/mt96cfd.html>.

15-18 ▼ Symposium on Quantum Theory and Simulation of Bulk, Surface and Interface Phenomena, *Raleigh, NC*. QTS Symposium, College of Physical and Mathematical Sciences, North Carolina State Univ., Box 8201, Raleigh, NC 27695-8201; e-mail qts@ncsu.edu; World Wide Web <http://www2.ncsu.edu/ncsu/pams/qts>.

15-19 4th Intl. Special Emphasis Symposium on Superalloys 718, 625, 706, and Derivatives, *Pittsburgh, PA*. E.A. Loria, Alloy 718-625-706 Committee, 1828 Taper Dr., Pittsburgh, PA 15241; (412) 221-5905; fax (412) 221-7355.

15-18 1997 Int'l Workshop on Superconductivity, *ISTEC '97, The Big Island, HI*. Dr. Tetsuji Kobayashi, Director, International Affairs Dept., ISTEC 34-3, Shimbashi 1-chome, Minato-ku, Tokyo 105, Japan; 81-3-3431-4004; fax 81-3-3431-4044; e-mail kokusai@istec.mxa.meshnet.or.jp. **MRS.**

15-19 **INTERpack '97: The ASME International, Intersociety Electronic and Photonic Packaging Conference & Exhibition**, *Honolulu, HI*. Dr. Ephraim Suhir, AT&T Bell Laboratories, Basic Research, Physical Science and Engineering Division, 600 Mountain Ave., Rm. 7D-326, Murray Hill, NJ 07974; (908) 582-5301; fax (908) 582-5570; e-mail suhir@hoggpa.att.com. **Endorsed.**

15-19 PACIFIC RIM/ASME Intl., Intersociety Electronic & Photonic Packaging Conf., *Mauna Lani, HI*. B. Bigalke, ASME, 345 E. 47th Street, New York, NY 10017; (212) 705-7057; fax (212) 705-7856; World Wide Web <http://www.asme.org>.

15-20 8th Intl. Symposium on Nondestructive Characterization of Materials, *Boulder, CO*. D. Harris, Center for Nondestructive Evaluation, 102 Maryland Hall, 3400 N. Charles St., The Johns Hopkins Univ., Baltimore, MD 21218-2689; (410) 516-5397; fax (410) 516-7249; e-mail cnde@jhvums.hcf.jhu.edu.

16-19 30th Intl. Symposium on Automotive Technology and Automation, *Florence, Italy*. ISATA, 32A Queen St., Croydon, CRO 1SY, UK; 44-181-6813069; fax 44-181-6861490; e-mail 100270.1263@compuserve.com; World Wide Web <http://www.spincom.com/isata>.

16-19 ▼ Intl. Chemical and Petroleum Industry Inspection Technology V Conf., *Houston, TX*. American Society for Nondestructive Testing, 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; (614) 274-6003; fax (614) 274-6899; World Wide Web <http://www.asnt.org>.

16-20 7th European Conf. on Applications of Surface and Interface Analysis, *Göteborg, Sweden*. I. Olejford, ECASIA '97, Chalmers Univ. of Technology, Dept. of Engineering Metals, S-412 96, Göteborg, Sweden; fax 46-31-7721262; e-mail olejford@em.chalmers.se; World Wide Web <http://www.em.chalmers.se/ecasia/ecasia97.htm>.

16-20 **ICAM '97/E-MRS '97 Spring Meeting**, *Strasbourg, France*. P. Siffert, E-MRS 1997 Spring Meeting, BP20, 67037 Strasbourg Cedex 2, France, (33) 03-88-10-65-43; fax (33) 03-88-10-62-93; e-mail EMRS@FRCPN11.IN2P3.FR. **E-MRS/IUMRS.**

18-19 3rd Annual Environmental Sampling, On-Site Analysis, and Sample Preparation Conf., *Pittsburgh, PA*. H. Nowicki, PACS, Inc., 409 Meade Dr., Coraopolis, PA 15108; (800) 367-2587; fax (412) 457-1214.

JULY 1997

18-20 ▼ TRI/Princeton Workshop on Characterization of Porous Materials: From Angstroms to Millimeters, *Princeton, NJ*. A.V. Niemark, TRI/Princeton, 601 Prospect Ave., Princeton, NJ 08542-0625; (609) 924-3150; fax (609) 683-7149; e-mail aniemark@triprinceton.org; World Wide Web http://pluto.njcc.com/~aneimark/copm_workshop.

25-27 3rd Synthesis, Processing and Modeling of Advanced Materials Conf., *Paris, France*. B. Roudebush, ASM Intl. European Office, Blvd. St. Michel 15, B-1040 Brussels, Belgium; 32-2-7431546; fax 32-2-7431550; e-mail 100332.670@compuserve.com.

25-27 ▼ 39th Electronic Materials Conf., *Ft. Collins, CO*. TMS Customer Service Dept., 420 Commonwealth Dr., Warrendale, PA 15086; (412) 766-9000; fax (412) 776-3770; e-mail csc@tms.org.

25-27 Fractals In Engineering, *Arcachon, France*. Conference Secretariat, INRIA Rocquencourt, Relations Exterieures, Bureau des cours et colloques, B.P. 105, 78153 LE CHESNAY Cedex, France; 33 1 39 63 50 53; fax 33 1 39 63 56 38; e-mail FE97@inria.fr; World Wide Web <http://www.rocq.inria.fr/fractales/FE97.html>.

26-28 6th Intl. Superconductive Electronics Conf., *Berlin, Germany*. ISEC '97 Conf. Secretariat, Dipl. Phys. Silvia Knappe, Phys.-Techn. Bundesanstalt, Abbestr. 10-12, 10587 Berlin, Germany; fax 49-30-3481490; e-mail isec97@ptb.de; World Wide Web <http://www.ptb.de/isec97/start.htm>.

26-28 ▼ Superconducting Materials Aspects: Research and Technology, *Liège, Belgium*. C. Lacrosse, Conf. Secretary, A.I.M. rue St. Gilles 31, B-4000 Liège, Belgium; 32-4-222-2946; fax 32-4-222-2382; e-mail aimulg@misc.ulg.ac.be.

29-5 The 3rd International Workshop in Russia Fullerenes and Atomic Clusters, *IWFAC'97, St. Petersburg, Russia*. Alexander Ya. Vul', Chair, Ioffe Physico-Technical Institute, 26 Polytechnicheskaya, 194021 St. Petersburg, Russia; 007-(812) 5156774; fax 007-(812) 2470073; e-mail fuller@vul.ioffe.rssi.ru.

30-3 3rd European Conf. on Applied Superconductivity, *Veldhoven, The Netherlands*. Convention Bureau Basics, P.O. Box 217, 7500 AE, Enschede, The Netherlands; 31-53-4894444; fax 31-53-4894442; e-mail a.spierenburg@basics.utwente.nl.

1-3 3rd Intl. Conf. on Computational Methods in Contact Mechanics, *Madrid, Spain*. L. Kerr, Contact Mechanics 97 Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-1-703-293223; fax 44-1-703-292853; e-mail liz@wessex.ac.uk; World Wide Web <http://www.wessex.ac.uk>.

2-4 ▼ Ultrasonics Intl. Conf., *Delft, The Netherlands*. S. Emsley, Ultrasonics 97, Elsevier Science Ltd., The Boulevard, Langford Lane, Kidlington, Oxon OX5 1GB, UK; 44-1865-843721; fax 44-1865-843958; e-mail s.emsley@elsevier.co.uk; World Wide Web <http://www.msc.cornell.edu/~ui97>.

6-9 Intl. Meeting on Low-Temperature Microscopy and Analysis, *Oxford, England*. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-18-65-248768; fax 44-18-65-791237.

7-11 ▼ Intl. Conf. on Applied Nonlinear Dynamics near the Millennium, *San Diego, CA*. e-mail andm97@dracula.ucsd.edu.

7-11 ▼ Thermomechanical Processing of Steels and Other Materials, *Wollongong, Australia*. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; (216) 338-5151; fax (216) 338-4634; e-mail memserv@po.asm-intl.org.

10-11 Annual Government Lab/Industry Technology Transfer Conf., *Arlington, VA*. L.W. Sircy, Technology Transfer Conferences, Inc., 325 Plus Park Blvd., #108, Nashville, TN 37217; (615) 366-0679; fax (615) 366-0695.

13-17 ▼ 7th Intl. Symposium on Silicon Molecular Beam Epitaxy, *Banff, Canada*. P. Lamoureux, Conf. Mgr., 7th Intl. Symposium on Si-MBE, Natl. Research Council of Canada, Ottawa, Ontario, Canada K1A 0R6; (613) 993-9431; fax (613) 993-7250; e-mail mbe97@nrc.ca; World Wide Web <http://www.nrc.ca/confserv/mbe97/welcome.html>.

13-18 Intl. Conf. on High Strength Concrete, *Kona, HI*. Engineering Foundation Conf., 345 E. 47th St., New York, NY 10017; (212) 705-7836; fax (212) 705-7441; e-mail engfnd@aol.com; World Wide Web <http://www.engfnd.org/engfnd>.

14-16 ▼ Symposium on Synthesis, Properties, and Applications of High Temperature Superconductors, *Queensland, Australia*. T. Chandra, Dept. of Materials Engineering, Univ. of Wollongong, Wollongong 2522, Australia; fax 61-42-213-112; e-mail t.chandra@uow.edu.au.

15-17 3rd Intl. Conf. on Computer Methods and Experimental Measurements for Surface Treatment Effects, *Oxford, UK*. L. Kerr, Surface Treatment 97 Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-1-703-293223; fax 44-1-703-292853; e-mail liz@wessex.ac.uk; World Wide Web <http://www.wessex.ac.uk>.

20-23 ▼ Intl. Metallographic Society Convention, *Seattle, WA*. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; (216) 338-5151; fax (216) 338-4634; e-mail memserv@po.asm-intl.org.

21-24 ▼ International Microscopy Meeting, *Chicago, IL*. N. Daerr, McCrone Research Inst., 2820 S. Michigan Ave., Chicago, IL 60616-3292; (312) 842-7100; fax (312) 842-1078; e-mail ndaerr@mcrl.org; World Wide Web <http://www.mcrl.org>.

21-25 19th Intl. Conf. on Defects in Semiconductors, *Aveiro, Portugal*. Doutora Helena Nazaré, Departamento de Física, Universidade de Aveiro, 3810 Aveiro, Portugal; 351-34-370-200; fax 351-34-28-600; e-mail mhnazare@fis.ua.pt or Gordon Davies, Physics Dept., King's College London, The Strand, London WC2R 2LS, England; 44-171-873-2573; fax 44-171-873-2423; e-mail g.davies@kcl.ac.uk.

27-31 Structures Under Extreme Loading Conditions: 1997 ASME Pressure Vessels and Piping Conf., *Orlando, FL*. Y.S. Shin, Dept. of Mechanical Engineering, Naval Postgraduate School, Monterey, CA 93943; (408) 656-2568; fax (408) 656-2238; e-mail yshin@me.nps.navy.mil.

27-1 13th Intl. Conf. on Ion Beam Analysis, *Lisboa, Portugal*. Conference Secretariat, IBA-13, Instituto Tecnológico e Nuclear, E.N. 10, 2685 Sacavém, Portugal; 351-1-9550021; fax 351-1-9941525; e-mail IBA13@aiff.cii.fc.ul.pt.

27-1 ▼ Intl. Conf. on Magnetism, *Cairns, Australia*. Intl. Conf. on Magnetism, 108 Church St., Hawthorn Victoria, Australia 3122; 61-3-9819-3700; fax 61-3-9819-5978; e-mail icm@meetingplanners.com.au.

27-1 Intl. Symposium on Optical Science, Engineering, and Instrumentation, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; (360) 676-3290; fax (360) 647-1445; e-mail spie@spie.org; World Wide Web <http://www.spie.org>.

27-1 Joint ICMC-CEC 1997 Conf., *Portland, OR*. Nancy Wilson, Exe-Me and Company, P.O. Box 25445, Portland, OR 97298-0445; (503) 292-2114; e-mail ewemeco@europa.com or Bill Warnes, Oregon State University, Mech. Engineering Dept., Corvallis, OR 97331-6001; (541) 737-7016; e-mail warnesw@enr.orst.edu.

28-1 Cryogenic Engineering Conf./Intl. Cryogenic Materials Conf., *Portland, OR*. CEC/ICMC, P.O. Box 25445, Portland, OR 97225-0445; (503) 292-2114; fax (503) 292-1375; e-mail jbarclay@me.uvic.ca; World Wide Web <http://www.orst.edu/groups/cec-icmc-97>.

28-1 ▼ Nonequilibrium Carrier Dynamics in Semiconductors, *Berlin, Germany*. HCIS-10, H. Krüger, Max-Born-Inst., Rudower Chaussee 6, D-12489 Berlin, Germany; fax 49-30-6392-1409; e-mail hcisx@mbi.fta-berlin.de.

AUGUST 1997

3-8 ▼ 8th European Conf. on Diamond, Diamond-Like, and Related Materials, and 4th Intl. Conf. on Applications of Diamond Films and Related Materials, *Edinburgh, Scotland*. Diamond 1997 Conf. Secretariat, 22 Plas Taliesin, Portway Village Marina, Penarth CF64 1TN, Wales, UK; 44-1222-700053; fax 44-1222-700665; e-mail enquiries@global-meeting.co.uk; World Wide Web <http://www.global-meeting.co.uk>.

3-8 ▼ Thermal Spray Processing of Nanoscale Materials, *Davos, Switzerland*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; (212) 705-7836; fax (212) 705-7441; e-mail engfnd@aol.com; World Wide Web <http://www.engfnd.org>.

10-14 ▼ Annual Meeting of the Microscopy Society of America, Microbeam Analysis Society, and The Histochemical Society, *Cleveland, OH*. Microscopy Society of America Business Office, (800) 538-3672; fax (508) 563-1211; e-mail BusinessOffice@MSA.microscopy.com; World Wide Web <http://www.msa.microscopy.com>.

11-21 ▼ NATO Advanced Study Inst. on Nanostructured Materials: Science and Technology, *St. Petersburg, Russia*. G-M. Chow, U.S. Naval Research Lab., Materials Science and Technology Div., Code 6323, Washington, DC 20375; (202) 767-3433; fax (202) 767-2623; e-mail gmchow@anvil.nrl.navy.mil.

17-20 Intl. Symposium on Materials Solutions for Environmental Problems, *Sudbury, Canada*. H. Mostaghaci, Advanced Materials and Plastics Branch, Industry Canada, 235 Queen St., Ottawa, Ontario K1A 0H5, Canada; (613) 954-5012; fax (613) 952-4209; e-mail mostaghaci.hamid@ic.gc.ca.

17-21 1997 Intl. Conf. on Neutron Scattering, *Toronto, Canada*. P.H. Green, Solid State Div., Oak Ridge National Lab., P.O. Box 2008, Oak Ridge, TN 37831-6033; (423) 576-1864; fax (423) 574-4143; e-mail phg@ornl.gov; World Wide Web <http://www.physics.utoronto.ca/icns/icns.html>.

24-29 9th Intl. Meeting on Ferroelectricity, *Seoul, Korea*. IMF-9 Secretariat, INTERCOM Convention Service, Inc., 4FL, Jisung Bldg., #645-20, Yeoksam 1-dong, Kangnam-ku, Seoul, 135-081, Korea; 82-2-568-3208; fax 82-2-565-2434; e-mail intercom@soback.kornet.nm.kr.

25-28 16th General Conf. of the Condensed Matter Division of the European Physical Society, *Leuven, Belgium*. The Secretary-General, 16th CMD-General Conf., Dept. Natuurkunde K. U. Leuven, Celestijnenlaan 200 D, B-3001 Leuven, Belgium; 32-16-327175; fax 32-16-327983.

25-29 ▼ 8th Intl. Conf. on II-VI Compounds, *Grenoble, France*. L.S. Dang, II-VI Conf. Secretariat, Lab. de Spectrométrie Physique, Univ. J. Fourier, Grenoble, B.P. 87, 38402 St. Martin d'Hères Cedex, France; fax 33-0476-514544; e-mail lesidang@spectro.grenet.fr; World Wide Web http://www.spectro.grenet.fr/~icc_2_6.

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27-29 4th Intl. Conf. on Computational Modeling of Free and Moving Boundary Problems, Ghent, Belgium. S. Owen, Moving Boundaries 97 Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-1-703-293223; fax 44-1-703-292853; e-mail sue@wessex.ac.uk; World Wide Web <http://www.wessex.ac.uk>.

31-5 14th Int'l Symposium on Chemical Vapor Deposition/EuroCVD Eleven, Paris, France. Electrochemical Society; (609) 737-1902; fax (609) 737-2743; e-mail ecs@electrochem.org; World Wide Web <http://www.electrochem.org>. **Endorsed.**

31-5 ▼ Intl. Conf. on Silicon Carbide, III-Nitrides, and Related Materials, Stockholm, Sweden. Stockholm Convention Bureau, ICSC/II—M'97, P.O. Box 6911, S-102 39 Stockholm, Sweden.

SEPTEMBER 1997

1-5 ▼ Intl. Conf. on Crystallographic Texture and Mechanical Anisotropy, Hyannis, MA. Engineering Foundation, 345 E. 47th St., New York, NY 10017; (212) 705-7836; fax (212) 705-7441; e-mail engfnd@aol.com; World Wide Web <http://www.engfnd.org>.

1-12 ▼ NATO Advanced Study Inst. on Gap Symmetry and Fluctuations in High-T_c Superconductors, Corse, France. D. Pavuna; 41-21-6933301; fax 41-21-6934666; e-mail pavuna@eldp.epfl.ch.

4-7 ▼ 5th Nepcon Thailand Intl. Electronics Manufacturing Technology Trade Exhibition and Conf., Bangkok, Thailand. R. Suksirivong, Reed Tradex Co., Reed Tradex Bldg., 323 Bond St., Muang Thong Thani, Nonthaburi 11120, Thailand; 66-2-503-2199; fax 66-2-503-4963.

7-10 6th Intl. Conf. on Ceramic Processing, Santa Barbara, CA. F.F. Lange, MRL, ENG II, Univ. of California at Santa Barbara, Santa Barbara, CA 93106; e-mail ceramics@mrl.ucsb.edu.

7-10 7th Intl. Conf. on Defect Recognition and Image Processing in Semiconductors, Berlin, Germany. DRIP VII Secretary, Ferdinand-Braun-Inst., Rudower Chaussee 5, D-12489 Berlin, Germany; 49-30-63922642; e-mail DRIPVII-fbh-ikz@fbh.fta-berlin.de.

7-11 24th Intl. Symposium on Compound Semiconductors, San Diego, CA. M. Melloch, Purdue Univ., 1285 Electrical Engineering Bldg., W. Lafayette, IN 47907-1285; (317) 494-3528; fax (317) 494-6441; e-mail melloch@ecn.purdue.edu.

7-20 Summer School on Superconductivity in Networks and Mesoscopic Structures, Siena, Italy. C. Giovannella, Dipartimento di Fisica, Univ. di Roma "Tor Vergata," Via della Ricerca Scientifica 1, I-00133 Rome, Italy; 39-6-72594524; fax 39-6-2023507; e-mail supnet@roma2.infn.it; World Wide Web <http://wwwas.roma2.infn.it/>.

8-10 ▼ 11th Intl. Conf. on Surface Modification Techniques, Paris, France. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; (216) 338-5151; fax (216) 338-4634; e-mail memserv@po.asm-intl.org.

13-15 3rd Okinaga Symposium on Materials Science and Engineering Serving Society, Makuhari, Chiba, Japan. S. Sōmiya, Teikyo Univ. of Science and Technology, 3-4-7 Seijo, Setagaya, Tokyo 157, Japan; 81-554-634411; fax 81-3-3415-6619.

14-18 ▼ ASM/TMS Materials Week and Materials Exposition; 17th ASM Heat Treating Society Conf.; and ASM Thermal Spray Society and DVS (German Welding Society) United Thermal Spray Conf.; Indianapolis, IN. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; (216) 338-5151; fax (216) 338-4634; e-mail memserv@po.asm-intl.org.

14-18 Conf. on Spectroscopies in Novel Superconductors, Cape Cod, MA. J. Pumphrey, Conf. Secretary, The Barnett Inst., Northeastern Univ., Boston, MA 02115; (617) 373-2868; fax (617) 373-2855.

14-19 ▼ Radiation Effects in Insulators—9, Knoxville, TN. REI-9 Secretariat, c/o J. Johnson, 100 Estabrook Hall, Univ. of Tennessee, Knoxville, TN 37996-2350; (423) 974-0816; (423) 974-4995; e-mail jewell@utk.edu.

15-17 ▼ Intl. Conf. on Fine Powder Processing, State College, PA. Particulate Materials Center, 147 Research Bldg. West, The Pennsylvania State Univ., University Park, PA 16802-6809; (814) 863-6156; fax (814) 863-9704; e-mail rgg5@psu.edu; World Wide Web <http://pmcenter.cerse.psu.edu>.

16-18 ▼ 4th IUMRS Intl. Conf., Chiba, Japan. Y. Masahiro, Materials and Structures Lab., Tokyo Inst. of Technology, 4259 Nagatsuta, Midori, Yokohama 226, Japan; 81-45-924-5323; fax 81-45-924-5358; e-mail iumrs1@riem.titech.ac.jp. **IUMRS.**

16-18 ▼ Intl. Induction Heat Treating Symposium, Indianapolis, IN. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; (216) 338-5151; fax (216) 338-4634; e-mail memserv@po.asm-intl.org.

21-24 Midwestern Mechanics Conf., Rapid City, SD. L. Kjerengtroen, S. Dakota School of Mines and Technology, Dept. of Mechanical Engineering, Rapid City, SD 57701; (605) 394-2409; fax (605) 395-2405; e-mail lkjereng@msmailgw.sdsmt.

21-25 5th Intl. Symposium on Advanced Materials, Islamabad, Pakistan. Secretariat, A.Q. Khan Research Laboratories, P.O. Box 905, Rawalpindi, Pakistan; 92-51-450734; fax 92-51-452487; e-mail 100074.172@compuserve.com.

21-26 2nd Intl. Symposium on Structural Intermetallics, Champion, PA. B. Kamperman, The Minerals, Metals & Materials Society, 420 Commonwealth Dr., Warrendale, PA 15086; (412) 776-9000, ext. 234; fax (412) 776-3770; e-mail kamperman@tms.org.

21-26 ▼ 10th Intl. Conf. on Surface Modification of Metals by Ion Implantation, Gatlinburg, TN. SMMIB-97, Attn.: V. Barnes, Oak Ridge Natl. Lab., Bldg. 3137, M.S. 6057, Oak Ridge, TN 37831-6057; e-mail smmib@ornl.gov.

28-1 ▼ Eastern Regional Conf. on Crystal Growth and Epitaxy, Atlantic City, NJ. R. Scripa, Univ. of Alabama at Birmingham, Dept. of Materials Engineering, 1150 10th Ave. South, Birmingham, AL 35294-4461; (205) 934-8453; fax (205) 934-8485; e-mail rscripa@eng.uab.edu.

28-3 MRS'97 Davos Switzerland, Scientific Basis for Nuclear Waste Management, Davos, Switzerland. NAGRA, Mrs. Verena Schatzmann, Hardstrasse 73, 5430 Wettingen, Switzerland; 41-56-437-12-53; fax 41-56-437-12-07; mrs97@nagra.ch. **MRS.**

29-30 Annual Canadian Univ./Crown Labs/Industry Technology Transfer Conf., Edmonton, Alberta, Canada. L.W. Sircy, Technology Transfer Conferences, Inc., 325 Plus Park Blvd., #108, Nashville, TN 37217; (615) 366-0679; fax (615) 366-0695.

29-1 2nd European Meeting on Integrated Ferroelectrics, Jouy-en-Josas, Campus Thomson, France. EMIF2 Secretariat, Groupe Francais de la Céramique, 47 à 73, Ave. Albert Thomas, 87065 Limoges Cedex, France; fax 33-5-55790998; e-mail jf.baumard@ensci.fr.

OCTOBER 1997

5-8 ▼ 16th North American Conf. on Molecular Beam Epitaxy, Ann Arbor, MI. P. Bhattacharya, Conf. Chair, Univ. of Michigan, Dept. of EE&CS, 1301 Beal Ave., Ann Arbor, MI 48109; (313) 763-6678; e-mail pkb@eecs.umich.edu.

5-8 Julian Szekely Memorial Symposium on Materials Processing, Cambridge, MA. TMS Customer Service Dept., 420 Commonwealth Dr., Warrendale, PA 15086; (412) 766-9000; fax (412) 776-3770; e-mail csc@tms.org.

6-8 12th Annual Technical Conf. of the American Society for Composites, Dearborn, MI. A. Duffer, Conf. Secretary, Mechanical Engineering Dept., Wayne State Univ., Detroit, MI 48202; (313) 577-3877; fax (313) 577-8789; e-mail gnewaz@eng.wayne.edu.

6-10 11th Intl. Conf. on Photopolymers and Intl. Conf. on Polyimides and Other Low K Dielectrics, McAfee, NJ. M.M. Khojasteh, IBM Corp., Microelectronics Div., 8/300-40E, 1580 Rt. 52, Hopewell Junction, NY 12533; (914) 894-5458; fax (914) 892-6256; e-mail mkhjqasteh@vnet.ibm.com.

11-17 OSA Annual Meeting, Long Beach, CA. Meetings Dept., Optical Society of America, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; (202) 223-0920; fax (202) 416-6100.

12-15 49th Pacific Coast Regional Meeting and American Ceramic Society Basic Science Division Meeting, San Francisco, CA. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; (614) 794-5890; fax (614) 899-6109; e-mail customersrv@acers.org.

12-16 ▼ 30th Intl. Symposium on Microelectronics, Philadelphia, PA. ISHM'97/Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; (703) 758-1060; (703) 758-1066; e-mail IMAPS@aol.com.

13-15 5th Intl. Symposium on Brittle Matrix Composites, Warsaw, Poland. A.M. Brandt, IFTR, Swietokrzyska 21, 00-049 Warsaw, Poland; fax 48-22-269815; e-mail abrandt@ippt.gov.pl.

14-16 ▼ ACerS Electronics Div. Meeting with the Intl. Microelectronics and Packaging Society, Philadelphia, PA. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; (614) 794-5890; fax (614) 899-6109; e-mail customersrv@acers.org; World Wide Web <http://www.acers.org>.

14-18 Radioactive Waste, Storage, Transportation, Recycling: Environment and Human Impact, St. Petersburg, Russia. Shpalernaja str. 49, 193015 St. Petersburg, Russia; 7-812-274-3796; fax 7-812-274-1707; e-mail kkv@prometey2.spb.su. **R-MRS, E-MRS.**

20-24 15th Intl. Conf. on Magnet Technology, Beijing, China. L. Lin, MT-15 Program Committee, Applied Superconductivity Div., Inst. of Electrical Engineering, Chinese Academy of Sciences, P.O. Box 2703, Beijing 100080, P.R. China; 86-10-6256-1492; fax 86-10-6256-0904; e-mail asd@piano.tee.ac.cn.

21-23 Medical Equipment Design and Technology Conf., Amsterdam, The Netherlands. Canon Communications, Inc., 3340 Ocean Park Blvd., Ste. 1000, Santa Monica, CA 90405-3216; (310) 392-5509; fax (310) 392-1557; World Wide Web <http://www.cancom.com>.

24-31 American Ceramic Society Glass and Optical Materials Division Joint Meeting with the Optical Society of America, Williamsburg, VA. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; (614) 794-5890; fax (614) 899-6109; e-mail customersrv@acers.org.

27-31 ▼ 2nd Intl. Conf. on Nitride Semiconductors, Tokushima, Japan. S. Yoshida, ICNS'97, Materials Science Div., Electrotechnical Lab., 1-1-4 Umezono, Tsukuba, Ibaraki 305, Japan; 81-298-54-5222; fax 81-298-58-5434; e-mail syoshida@etl.go.jp; World Wide Web <http://www-icns.ee.tokushima-u.ac.jp>.

27-31 ▼ 23rd Intl. Symposium for Testing and Failure Analysis, Santa Clara, CA. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; (216) 338-5151; fax (216) 338-4634; e-mail memserv@po.asm-intl.org.

29-1 Annual Convention of the Composites Fabricators Association and the Society for the Advancement of Material and Process Engineering, *Orlando, FL*. M. Henriksen, COMPOSITES 97, Composites Fabricators Association, 8201 Greensboro Dr., Ste. 300, McLean, VA 22102; (703) 610-9025; fax (703) 610-9005; e-mail cfa.info@cfa.hq.org.

NOVEMBER 1997

4-8 Unified Intl. Technical Conf. on Refractories, *New Orleans, LA*. Jerry E. Elliott, The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; (614) 794-5666; fax (614) 899-6109; e-mail elliot@acers.org.

16-19 1997 Intl. Conf. on Tungsten, Refractory Metals, and Alloys, *Orlando, FL*. Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540; (609) 452-7700; fax (609) 987-8523; e-mail info@mpif.org.

16-21 1997 Congress of the American Society of Mechanical Engineers, *Dallas, TX*. G.J. Wiens, Program Chair, Dept. of Mechanical Engineering, 237 MEB, Univ. of Florida, Gainesville, FL 32611-6300; (904) 392-0806; fax (904) 392-1071; e-mail gwiens@cimar.me.ufl.edu.

17-18 Midwest Univ. Industry Technology Transfer Conf., *Chicago, IL*. L.W. Sircy, Technology Transfer Conferences, Inc., 325 Plus Park Blvd., #108, Nashville, TN 37217; (615) 366-0679; fax (615) 366-0695.

DECEMBER 1997

1-5 **MRS Fall Meeting**, *Boston, MA*. Materials Research Society, 9800 McKnight Rd., Pittsburgh, PA 15237-6006; (412) 367-3003; fax (412) 367-4373; World Wide Web <http://www.mrs.org/>. **MRS.**

16-20 ▼ 9th Intl. Workshop on Physics of Semiconductor Devices, *Delhi, India*. S.K. Agarwal, Secretary, IWPSD-97, Solid State Physics Lab., Lucknow Rd., Timarpur, Delhi-110054, India; 91-11-238739; fax 91-11-2913609; e-mail ska@drsspl.ren.nic.in.

APRIL 1998

13-17 **MRS Spring Meeting**, *San Francisco, CA*. Materials Research Society, 9800 McKnight Road, Pittsburgh, PA 15237-6006; (412) 367-3003; fax (412) 367-4373; World Wide Web <http://www.mrs.org/>. **MRS.**

JULY 1998

12-16 3rd Pacific Rim Intl. Conf. on Advanced Materials and Processing, *Honolulu, HI*. P. Weiss, PRICM 3 Program Coordinator, TMS, 420 Commonwealth Dr., Warrendale, PA 15086-7514; (412) 776-9000, ext. 227; fax (412) 776-3770; e-mail weiss@tms.org.

AUGUST 1998

24-27 ▼ Electroceramics VI, 11th Intl. Symposium on Applications of Ferroelectrics, and 4th European Conf. on Applications of Polar Dielectrics, *Montreux, Switzerland*. ECAPD & ISAF, Electroceramics VI, LC-DMX-EPFL, CH-1015 Lausanne, Switzerland; e-mail electro@lc.dmx.epfl.ch; World Wide Web <http://dmxwww.epfl.ch/lc/electro/home.html>.

26-31 12th Intl. Conf. on Crystal Growth, *Jerusalem, Israel*. ICCG 12, c/o Intl. Travel & Congresses Ltd., P.O. Box 29313, Tel Aviv 61292, Israel; 972-3-5102538; fax 972-3-5160604.

SEPTEMBER 1998

13-18 Applied Superconductivity Conf., Palm Desert, CA. Centennial Conferences, (303) 499-2299; fax (303) 499-2599; e-mail centennial@orci.com.

15-19 ▼ 4th Intl. Conf. on Computer Simulation of Radiation Effects in Solids, *Okayama, Japan*. Y. Yamamura, Okayama Univ. of Science, Ridai-cho, Okayama 700, Japan; 81-86-252-3161; fax 81-86-255-7700; e-mail yama@dap11.ous.ac.jp. □

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